

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	1393	(bell and boyd and lloyd).att.	US-PGPUB; USPAT	OR	ON	2006/02/06 15:11
L3	12	(bell and boyd and lloyd).att. and transfer\$4.ti.	US-PGPUB; USPAT	OR	ON	2006/02/06 15:14
L4	40	(bell and boyd and lloyd).att. and transfer\$4.ab.	US-PGPUB; USPAT	OR	ON	2006/02/06 15:18
L5	13	(bell and boyd and lloyd).att. and (pressure adj (sensitiv\$3 activat\$3))	US-PGPUB; USPAT	OR	ON	2006/02/06 15:18
L7	8	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and ((strip\$4 remov\$4 peel\$4) same (substrate\$2 layer\$2)) and (wire\$2 wiring) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities) same conduct\$3) and ((attach\$3 embed\$4 insert\$3 press\$3) same (device element electrode)) and (simple with matrix with display) and (active with matrix with display)	US-PGPUB; USPAT	OR	ON	2006/02/06 16:31
L8	25	("428" "156").clas. and (adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (simple with matrix with display) and (active with matrix with display)	US-PGPUB; USPAT	OR	ON	2006/02/06 16:34
L9	4	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and (strip\$4 remov\$4 peel\$4) and (wire\$2 wiring) and (conduct\$3) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities)) and ((simple with matrix with display) same voltage) and ((active with matrix with display) same voltage)	US-PGPUB; USPAT	OR	ON	2006/02/06 16:37

L10	7	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and (strip\$4 remov\$4 peel\$4) and (wire\$2 wiring) and (conduct\$3) and ((opening\$3 via\$2 holes cavity cavities)) and ((simple with matrix with display) same voltage) and ((active with matrix with display) same voltage)	US-PGPUB; USPAT	OR	ON	2006/02/06 16:37
S1	2504	("428" "156").clas. and (adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's")	US-PGPUB; USPAT	OR	ON	2006/02/06 16:34
S2	540	("428" "156").clas. and (adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3	US-PGPUB; USPAT	OR	ON	2006/02/02 15:08
S3	395	("428" "156").clas. and (adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and substrate\$2	US-PGPUB; USPAT	OR	ON	2006/02/02 15:08
S4	80	("428" "156").clas. and (adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and substrate\$2 and (red and blue and green)	US-PGPUB; USPAT	OR	ON	2006/02/02 15:15
S5	761	(adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and (red and blue and green) and conduct\$4 and method.ti.	US-PGPUB; USPAT	OR	ON	2006/02/02 15:26
S6	761	(adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and (red and blue and green) and method.ti.	US-PGPUB; USPAT	OR	ON	2006/02/02 15:27

S7	360	(adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and (red and blue and green) and (harden cure\$2 curing) and method.ti.	US-PGPUB; USPAT	OR	ON	2006/02/02 15:33
S8	16	(adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and (red and blue and green) and (harden cure\$2 curing) and "156".clas.	US-PGPUB; USPAT	OR	ON	2006/02/02 15:34
S9	360	(adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (wire\$3 wiring\$2) and conduct\$3 and (red and blue and green) and (harden cure\$2 curing) and method.ti.	US-PGPUB; USPAT	OR	ON	2006/02/02 15:51
S10	49	(adhesive\$3 glue\$3 sticky\$3 adher\$3) and (transfer\$3) and ("light emitting diode" "LED" "LED's") and (red and blue and green) and (harden cure\$2 curing) and "156".clas.	US-PGPUB; USPAT	OR	ON	2006/02/02 15:52
S11	7	("20050042391" "3658616" "5601884" "5849857" "5953091" "6001277" "6064524").PN.	US-PGPUB; USPAT	OR	ON	2006/02/03 08:38
S12	3971	(sony adj corporation).as. and device.ti.	US-PGPUB; USPAT	OR	ON	2006/02/03 08:38
S13	15	(sony adj corporation).as. and (device and transfer and method).ti.	US-PGPUB; USPAT	OR	ON	2006/02/03 08:41
S14	3	("20020096994" "20030157741" "20030162463").PN.	US-PGPUB; USPAT	OR	ON	2006/02/03 11:28
S15	6	((pressure with (sensitive activat\$4) with adhesive) same ((thermal\$3 heat) adj (sensitive acitvat\$4))) and (device and transfer\$4 and method).ab.	US-PGPUB; USPAT	OR	ON	2006/02/03 09:47
S16	3	((pressure with (sensitive activat\$4) with adhesive) same ((thermal\$3 heat) adj (sensitive acitvat\$4))) and (element and transfer\$4 and method).ab.	US-PGPUB; USPAT	OR	ON	2006/02/03 09:48
S17	44	((pressure with (sensitive activat\$4) with adhesive) same ((thermal\$3 heat) adj (sensitive acitvat\$4))) and (transfer\$4 and method).ab.	US-PGPUB; USPAT	OR	ON	2006/02/03 09:49

S18	21	((pressure with (sensitive activat\$4) with adhesive) same ((thermal\$3 heat) adj (sensitive acitvat\$4))) and (transfer\$4 and method).ti.	US-PGPUB; USPAT	OR	ON	2006/02/03 09:50
S19	1	((pressure with (sensitive activat\$4) with adhesive) same ((thermal\$3 heat) adj (sensitive acitvat\$4))) and (transfer\$4 and device).ti.	US-PGPUB; USPAT	OR	ON	2006/02/03 09:50
S20	0	"10511699"	US-PGPUB; USPAT	OR	ON	2006/02/03 11:29
S21	2521	doi.in.	US-PGPUB; USPAT	OR	ON	2006/02/03 11:29
S22	108	doi-masato.in.	US-PGPUB; USPAT	OR	ON	2006/02/03 11:39
S23	5	("4841194" "4899081").PN. OR ("5426342").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/03 11:34
S24	33	S22 and transfer\$4	US-PGPUB; USPAT	OR	ON	2006/02/03 11:44
S25	1	"20020096994"	US-PGPUB; USPAT	OR	ON	2006/02/03 13:29
S26	13	("20020115265" "20020171089" "5206749" "5258320" "5272326" "5438241" "5739800" "6007664" "6204079" "6277711" "6283693" "6559905" "6649012").PN.	US-PGPUB; USPAT	OR	ON	2006/02/03 14:42
S27	3453	(insulat\$4 with ((polyamide acrylic) adj resin))	US-PGPUB; USPAT	OR	ON	2006/02/03 14:43
S28	812	(insulat\$4 near3 ((polyamide acrylic) adj resin))	US-PGPUB; USPAT	OR	ON	2006/02/03 14:43
S29	9	(insulat\$4 near3 ((polyamide acrylic) adj resin)) and "156".clas.	US-PGPUB; USPAT	OR	ON	2006/02/03 14:58
S30	575	(partially adj embedd\$3) and ((device elements) with (transfer\$4))	US-PGPUB; USPAT	OR	ON	2006/02/03 14:59
S31	7	(partially adj embedd\$3) and ((device elements) with (transfer\$4)).ti.	US-PGPUB; USPAT	OR	ON	2006/02/03 15:00
S32	93	(partially adj embedd\$3) and ((device elements) with (transfer\$4)).ab.	US-PGPUB; USPAT	OR	ON	2006/02/03 15:01
S33	91	(partially adj embedd\$3) and ((device elements) with (transfer\$4)) and (LED (light adj emitting adj diode))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:21
S34	1	(partially adj embedd\$3) and ((transfer\$4)).ti. and (LED (light adj emitting adj diode))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:22

S35	22	(partially adj embedd\$3) and ((transfer\$4)).ab. and (LED (light adj emitting adj diode))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:22
S36	33	(partially adj embedd\$3) and ((transfer\$4)).ti. and (LED (light adj emitting adj diode) piezoelectric transistor resistance diode)	US-PGPUB; USPAT	OR	ON	2006/02/03 15:34
S37	39	(partially near3 embedd\$3) and ((transfer\$4)).ti. and (LED (light adj emitting adj diode) piezoelectric transistor resistance diode)	US-PGPUB; USPAT	OR	ON	2006/02/03 15:35
S38	4	(partially near3 embedd\$3) and ((transfer\$4)).ti. and (LED (light adj emitting adj diode) piezoelectric transistor diode (liquid adj crystal))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:43
S39	4885	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and (strip\$4 remov\$4 peel\$4) and (wire\$2 wiring) and (conduct\$3) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities))	US-PGPUB; USPAT	OR	ON	2006/02/06 16:34
S40	2262	("438").clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and (strip\$4 remov\$4 peel\$4) and (wire\$2 wiring) and (conduct\$3) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:49
S41	3081	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and (strip\$4 remov\$4 peel\$4) and (wire\$2 wiring) and (conduct\$3) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities)) and ((attach\$3 embed\$4 insert\$3 press\$3) same (device element electrode))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:52

S42	1627	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and (strip\$4 remov\$4 peel\$4) and (wire\$2 wiring) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities) same conduct\$3) and ((attach\$3 embed\$4 insert\$3 press\$3) same (device element electrode))	US-PGPUB; USPAT	OR	ON	2006/02/03 15:53
S43	1407	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and ((strip\$4 remov\$4 peel\$4) same (substrate\$2 layer\$2)) and (wire\$2 wiring) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities) same conduct\$3) and ((attach\$3 embed\$4 insert\$3 press\$3) same (device element electrode))	US-PGPUB; USPAT	OR	ON	2006/02/06 16:30
S44	116	("438" "156" "313" "445" "428"). clas. and ((substrate\$2 layer\$2) same (adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2)) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (harden\$3 cur\$3 solidify\$3)) and ((strip\$4 remov\$4 peel\$4) same (substrate\$2 layer\$2)) and (wire\$2 wiring) and ((adhesive\$2 adhere\$2 resin\$2 paste\$2 glue\$2) same (opening\$3 via\$2 holes cavity cavities) same conduct\$3) and ((attach\$3 embed\$4 insert\$3 press\$3) same (device element electrode)) and (pressure adj (sensitive activat\$3))	US-PGPUB; USPAT	OR	ON	2006/02/06 08:35
S45	13	("20020115265" "20020171089" "5206749" "5258320" "5272326" "5438241" "5739800" "6007664" "6204079" "6277711" "6283693" "6559905" "6649012").PN. OR ("6872635"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/06 08:26
S46	4071	"Semiconductor Energy Laboratory". as.	US-PGPUB; USPAT	OR	ON	2006/02/06 08:35

S47	4	"Semiconductor Energy Laboratory". as. and (transfer).ti.	US-PGPUB; USPAT	OR	ON	2006/02/06 15:10
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